	1	2		3	4	5	1	6	7	1	8	
	Product Name: breakout adapter	ZX230ABR USB 3.0 3	8.1 Test Board - Typ	pe uAB Receptac	le Transmitter & Rec	eiver Test Fixture		2.0	06"(52.3mm)		37"(47.5mm)	
F	Product Description:	High Speed Inter-Chip and Receiver test fixtur	HSIC USB 2.0 - Sup e (breakout Adapter	perSpeed USB Inte r) with the USB2.0	r-Chip USB 3.0 test b USB 3.0 Type uAB c	ooard Transmitter onnector	▲ ▲	000	ME & GI		No.) F
		Designed meeting elect SCC profiles tests. Slev	trical compliance tes w, Voltage levels and	ting; eye diagram, d more).	jitter (random, determ	iinistic, total jitter,	1.00"(25.4mm)	esa.	E IA			
		Designed in 4 layer - 10	00 Ω differential trace	e impedance - elec	trical test measureme	nt requirements.		ai,	RU.			
Е		Includes : USB3.0 Typ Accessible 0.1" (2.54m	e uAB Receptacle w m) pitch header, ena	vith standard SMA of a bling "Power meas	connectors. surement" of the VBUS	8.	1.20"(30.5mm)	S9 F		YBJZ.		E
	ZX230 Insertion loss Ty Freq. Log Mag	(-dB)								ere + XA		
	100MHz 0.054 1.25GHz 0.6337 2.5GHz 1.468	75	Using 7X230ABP(T	vpe uAB Plug) with	7X2304BR(type u4	Recentacle)	×	O)-
	5GHz 2.5602	²⁵ Network Ar	nalyzer: Agilent, Moo	del E5071C 4 ch. 8	n ZX230ABR(type uAl 3.5GHz				1 1-1	1-1	-	
D		cal test, Clock Jitter mea		am, characterizatio	n test,	000 4 410						D
	Mates with : Type u 3.0 Plug	AB – High Speed Inter- g	Chip HSIC USB 2.0	- SuperSpeed USI	3 Inter-Chip Specificat	ion		-NG O	Type mirco AB Rec	-	Power Function	
		Brass with Gold finish 5 0.1" center, 0.025" SC		•	Insulator: PTFE				1 VB 2 DI 3 DI	N 2	GND VBUS	_ []
с	-	Compatible with Agilen		-	procedure	. Sing	e Xve		4 IC 4 GN	D Pin D 1	E	c
		0 USB 3.0 Type uAB R ignments listed.	eceptacle and the r	neader Circuit Diagr	am		AVCSS W		5 R) 6 R) 7 GN	(+ 3	ID 1.1M Ω to GND	
		Table below lists the sta USB 2.0 and USB 3.0 s		Ē	C1 0402 SMD 0.1μF	One			8 TX 9 TX			
	USB Low Speed USB 2.0 1.5M	bps		SMA Connectors	0402 SMD				VBUS Power measu Use JVBUS for powe			
в	Full Speed USB 2.0 12Mb High Speed USB 2.0 480M	ps Ibps			RX+ Type mi			Annual III	Note ALL ZEB	AX products are RoHS complian	t and Lead Free unless otherwise in	B
	SuperSpeed USB3.0 5Gbp	DS				_						
								S	LEBAX TEC ANTA CRUZ, CA U WW.ZEBAX.COM			[]
Δ								A	PECIFIED DIMENSIO RE INCHES (MM). OHS COMPLIANT)NS	LY DRAWING 230ABR USB 3.0 Tes ard	it 🛕
		IFICATIONS, DRAWINGS, PUBLICATIONS, A TH RESPECT TO THE MATERIALS, AND EXP			-) ARE BEING PROVIDED "AS IS." ZEBAX		D,	D	ESCRIPTION:HS	IC USB 2.0 Supers		B 3.0
	Information furnished is believed to be accurate Specifications mentioned in this publication are	e and reliable. However, Zebax Technologies a subject to change without notice. This publicati	ssumes no responsibility for the conseque ion replaces all other information previous	ences of use of such information or for sly supplied. Zebax Technologies prov	or any infringement of patents or other rights lucts are not authorized as in life support de	of third parties that may result from its use vices or systems.	е.	CH	HECKED: M. MARINA	DRAWN: SLAVIK	REVISSION: 1. SHEET: 1 OF	0
"	1	2		3	Λ	5		6	7		8	

ESCRIPTION: HSIC USB 2.0 SuperSpeed Inter-Chip USB 3.0 Test Board – Type uAB Receptacle breakout adapter Test Fixture									
ECKED:		REVISSION: 1.0							
M. MARINA	SLAVIK	STERNE 1 OF 1							